

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5515777

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHINMAYA PADHY	04/09/2019
KUO-CHUN LEE	05/01/2019
ANSAH AHMED SHEIK	04/09/2019
VISHNU NAMBOODIRI KARAKKAD KESAVAN NAMBOODIRI	04/20/2019
THEEKSHA ATHOOR PERUMAL	04/09/2019
RAJESH GOPALA KRISHNAN	04/09/2019
RECEIVING PARTY DATA	
Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16363876
CORRESPONDENCE DATA	
Fax Number:	(571)432-0808
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5714320800
Email:	Jcato@harrityllp.com
Correspondent Name:	HARRITY AND HARRITY, LLP
Address Line 1:	11350 RANDOM HILLS ROAD
Address Line 2:	SUITE 600
Address Line 4:	FAIRFAX, VIRGINIA 22030
ATTORNEY DOCKET NUMBER:	190587
NAME OF SUBMITTER:	KYLIE PAIGE
SIGNATURE:	/Kylie Paige/
DATE SIGNED:	05/09/2019

Total Attachments: 9

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ASSIGNMENT

WHEREAS, WE,

1. Chinmaya PADHY, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
2. Kuo-Chun LEE, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
3. Anisah Ahmed SHEIK, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
4. Vishnu Namboodiri KARAKKAD KESAVAN NAMBOODIRI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
5. Theeksha ATHOOR PERUMAL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
6. Rajesh GOPALA KRISHNAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **PREVENTING FREQUENT BEAM SWITCHING** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s), **16/363,876** filed **March 25, 2019**, Qualcomm Reference Number **190587**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications,

continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Hyderabad, on Apr. 9, 2019
City, State / Date

Chimmaya Padhy
Chimmaya PADHY

Done at _____, on _____
City, State / Date

Kuo-Chun LEE

Done at Hyderabad, Telangana, on April 9, 2019
City, State / Date

SK. Ansah Ahmed
Ansah Ahmed SHEIK

Done at _____, on _____
City, State / Date

Vishnu Namboodiri KARAKKAD
KESAVAN NAMBOODIRI

Done at Hyderabad, Telangana, on April 9, 2019
City, State / Date

A.P. Theeksha
Theeksha ATHOOR PERUMAL

Done at Hyderabad, Telangana, on April 9, 2019
City, State / Date

Rajesh P. H.
Rajesh GOPALA KRISHNAN

ASSIGNMENT

WHEREAS, WE,

1. Chinmaya PADHY, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
2. Kuo-Chun LEE, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
3. Ansah Ahmed SHEIK, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
4. Vishnu Namboodiri KARAKKAD KESAVAN NAMBOODIRI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
5. Theeksha ATHOOR PERUMAL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,
6. Rajesh GOPALA KRISHNAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 US,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **PREVENTING FREQUENT BEAM SWITCHING** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/363,876 filed **March 25, 2019**, Qualcomm Reference Number **190587**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications,

continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;


AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State Date

Chinmaya PADHY

Done at San Diego, on 5/1/2019
City, State Date


Kuo-Chun LEE

Done at _____, on _____
City, State Date

Ansah Ahmed SHEIK

Done at _____, on _____
City, State Date

Vishnu Namboodiri KARAKKAD
KESAVAN NAMBOODIRI

Done at _____, on _____
City, State Date

Theeksha ATHOOR PERUMAL

Done at _____, on _____
City, State Date

Rajesh GOPALA KRISHNAN

ASSIGNMENT

WHEREAS, WE,

1. **Chinmaya PADHY**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,
2. **Kuo-Chun LEE**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,
3. **Ansah Ahmed SHEIK**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,
4. **Vishnu Namboodiri KARAKKAD KESAVAN NAMBOODIRI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,
5. **Theeksha ATHOOR PERUMAL**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,
6. **Rajesh GOPALA KRISHNAN**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121 US**,

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continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

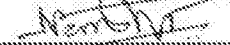
AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State Date Chinmaya PADHY

Done at _____, on _____
City, State Date Kuo-Chun LEE

Done at _____, on _____
City, State Date Ansah Ahmed SHEIK

Done at San Diego, CA, on 20th April 19
City, State Date 
Vishnu Namboodiri KARAKKAD
KESAVAN NAMBOODIRI

Done at _____, on _____
City, State Date Theeksha ATHOOR PERUMAL

Done at _____, on _____
City, State Date Rajesh GOPALA KRISHNAN